

# ThinkSystem Xilinx Alveo U50 Data Center Accelerator Adapter

## Product Guide

The ThinkSystem Xilinx Alveo U50 Data Center Accelerator Adapter is an advanced programmable computational accelerator that provides optimized acceleration for workloads in financial computing, machine learning, computational storage, high performance computing, and database search and analysis. The low-profile adapter is built on Xilinx UltraScale+ architecture includes 8GB HBM2 memory, 100GbE networking, and a PCIe 4.0 host interface. The Xilinx Vitis and Vitis AI development tools enable both Xilinx and third-party accelerated applications and solutions.

The following figure shows the ThinkSystem Xilinx Alveo U50 Data Center Accelerator Adapter.

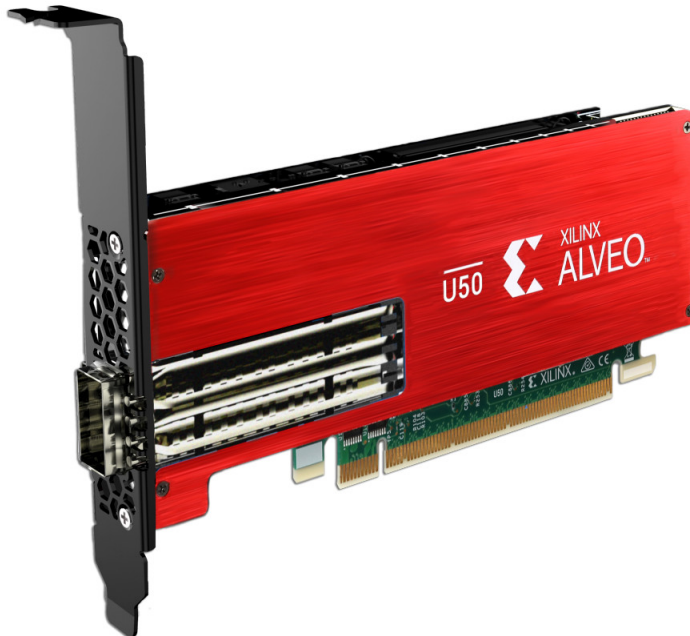


Figure 1. ThinkSystem Xilinx Alveo U50 Data Center Accelerator Adapter

## **Did you know?**

Customers can use the Xilinx Vitis Unified Software Platform to develop accelerated applications using RTL, C/C++ or OpenCL programming languages. Customers can also work with a growing ecosystem of hardware-accelerated partner libraries and pre-built applications to maximize their investment in on-premise data acceleration.

Some of the key 3rd party solutions available today are with Graph Analytics with TigerGraph, and Storage compression / decompression with Eideticom, with additional solutions being constantly developed.

## Part number information

The following table shows the part number for the adapter.

Table 1. Ordering information

Part number	Feature code	Description
4XC7A76757	BLC2	ThinkSystem Xilinx Alveo U50 Data Center Accelerator Adapter

The part numbers include the following:

- One Xilinx adapter
- Low-profile (2U) and full-height (3U) adapter brackets
- Documentation

## Supported transceivers and cables

This section lists the supported transceivers and cables.

Table 2. Supported transceivers

Part number	Feature code	Description
100Gb transceivers		
4M27A67042	BFH1	Lenovo 100Gb SR4 QSFP28 Ethernet Transceiver

The following table lists the supported fiber optic cables and Active Optical Cables.

Table 3. Optical cables

Part number	Feature code	Description
QSFP 40Gb Optical Cables (these cables require a transceiver)		
00VX003	AT2U	Lenovo 10m QSFP+ MPO-MPO OM3 MMF Cable
00VX005	AT2V	Lenovo 30m QSFP+ MPO-MPO OM3 MMF Cable
QSFP28 100Gb Ethernet Active Optical Cables		
7Z57A03546	AV1L	Lenovo 3m 100G SFP28 Active Optical Cable

The following table lists the supported direct-attach copper (DAC) cables.

Table 4. Copper cables

Part number	Feature code	Description
QSFP-to-QSFP 40Gb Cables		
49Y7890	A1DP	1m QSFP+ to QSFP+ Cable
49Y7891	A1DQ	3m QSFP+ to QSFP+ Cable
00D5810	A2X8	5m QSFP+ to QSFP+ Cable
00D5813	A2X9	7m QSFP+ to QSFP+ Cable
QSFP28 100Gb Ethernet Passive DAC Cables		
7Z57A03561	AV1Z	Lenovo 1m Passive 100G QSFP28 DAC Cable
7Z57A03562	AV20	Lenovo 3m Passive 100G QSFP28 DAC Cable
7Z57A03563	AV21	Lenovo 5m Passive 100G QSFP28 DAC Cable

## Features

The ThinkSystem Xilinx Alveo U50 Data Center Accelerator Adapter offers a number of features, including the following:

- Built for Performance & Efficiency
  - Faster application performance from 8GB of HBM memory (32 AXI channel access) and PCIe Gen4 interconnect
  - Low latency network capability through 100GbE networking
- Optimized Performance Across Broadest Range of Workloads
  - Accelerates compute, network, storage workloads
  - Maximized and future proof application performance as workloads and algorithms evolve through reconfigurable fabric - unlike fixed-architecture alternatives
- Deploy in Any Server – From On-premises to Cloud
  - Built for scale out architectures with a low-profile form factor and low 75-watt power envelope
- Powerful Developer Platform
  - Take advantage of a large and growing library of Xilinx and partner applications
  - Develop differentiated solutions leveraging Xilinx’s [Vitis unified software platform](#)
- Computational Storage Acceleration
  - Alveo U50 delivers the fastest and most flexible PCIe-based compression/decompression acceleration
  - Lower cost – Alveo U50 accelerated compression delivers 33% lower cost. (Based on 10GB/sec throughput and 2:1 compression)
- Financial Simulation – Grid Computing
  - Fastest time to insight
  - Reduced operational costs and maximum power efficiency
  - Deterministic latency delivers consistent performance
- Ultra-Low Latency Networking
  - 20x lower latency
  - Alveo U50 delivers sub-500ns trading time vs CPU latency of 10µs
  - Deterministic throughput timing

- Deep Learning Inference Acceleration
  - 10x higher throughput – translated symbols per second
  - 25x lower latency
  - Significantly improved power efficiency per node
- Database Analytics Acceleration
  - Higher query throughput & response time than CPU
  - Higher cost effectiveness per node
  - Reduced Operational cost
  - Real time results

## Technical specifications

The Xilinx Alveo U50 adapter has the following specifications:

- Architecture: UltraScale+
- Form factor: single-slot low-profile half-length
- Logic resources:
  - Lookup tables: 872,000
  - Registers: 1,743,000
  - DSP slices: 5,952
- Memory:
  - 8 GB HBM2 high-bandwidth memory
  - Bandwidth: 316 GB/s peak, 201 GB/s nominal
- Network interface: 1-port QSFP28 (100GbE)
- Clock precision: IEEE 1588
- Host interface: PCIe 3.0 x16, dual PCIe 4.0 x8, CCIX
- Thermal solution: Passive
- Power (TDP): 75W maximum, 50W typical

## Server support

The following tables list the ThinkSystem servers that are supported.

Table 5. Server support (Part 1 of 5)

Part Number	Description	AMD V3				2S Intel V3/V4				Multi Node V3	1S V3							
		SR635 V3 (7D9H / 7D9G)	SR655 V3 (7D9F / 7D9E)	SR645 V3 (7D9D / 7D9C)	SR665 V3 (7D9B / 7D9A)	ST650 V3 (7D7B / 7D7A)	SR630 V3 (7D72 / 7D73)	SR650 V3 (7D75 / 7D76)	SR630 V4 (7DG8 / 7DG9)	SR650 V4 (7DGC / 7DGD)	SR650a V4 (7DGC / 7DGD)	SD535 V3 (7DD8 / 7DD1)	SD530 V3 (7DDA / 7DD3)	SD550 V3 (7DD9 / 7DD2)	ST45 V3 (7DH4 / 7DH5)	ST50 V3 (7DF4 / 7DF3)	ST250 V3 (7DCF / 7DCE)	SR250 V3 (7DCM / 7DCL)
4XC7A76757	ThinkSystem Xilinx Alveo U50 Data Center Accelerator Adapter	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N

Table 6. Server support (Part 2 of 5)

Part Number	Description	4S 8S Intel V3/V4				GPU Rich				Edge									
		SR850 V3 (7D97 / 7D96)	SR860 V3 (7D94 / 7D93)	SR950 V3 (7DC5 / 7DC4)	SR850 V4 (7DJT / 7DJS)	SR860 V4 (7DJQ / 7DJN)	SR670 V2 (7Z22 / 7Z23)	SR675 V3 (7D9Q / 7D9R)	SR680a V3 (7DHE)	SR680a V3 B200 (7DM9)	SR685a V3 (7DHC)	SR780a V3 (7DJ5)	SR680a V4 (7DMK)	SE100 (7DGR)	SE350 (7Z46 / 7D1X)	SE350 V2 (7DA9)	SE360 V2 (7DAM)	SE450 (7D8T)	SE455 V3 (7DBY)
4XC7A76757	ThinkSystem Xilinx Alveo U50 Data Center Accelerator Adapter	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N

Table 7. Server support (Part 3 of 5)

Part Number	Description	Super Computing						1S Intel V2		2S Intel V2		AMD V1					
		SC750 V4 (7DDJ)	SC777 V4 (7DKA)	SD665 V3 (7D9P)	SD665-N V3 (7DAZ)	SD650 V3 (7D7M)	SD650-I V3 (7D7L)	SD650-N V3 (7D7N)	ST50 V2 (7D8K / 7D8J)	ST250 V2 (7D8G / 7D8F)	SR250 V2 (7D7R / 7D7Q)	ST650 V2 (7Z75 / 7Z74)	SR630 V2 (7Z70 / 7Z71)	SR650 V2 (7Z72 / 7Z73)	SR635 (7Y98 / 7Y99)	SR655 (7Y00 / 7Z01)	SR645 (7D2Y / 7D2X)
4XC7A76757	ThinkSystem Xilinx Alveo U50 Data Center Accelerator Adapter	N	N	N	N	N	N	N	N	N	N	Y	Y	N	N	Y	N

Table 8. Server support (Part 4 of 5)

Part Number	Description	Dense V2				4S V2	8S	4S V1		1S Intel V1				
		SD630 V2 (7D1K)	SD650 V2 (7D1M)	SD650-N V2 (7D1N)	SN550 V2 (7Z69)	SR850 V2 (7D31 / 7D32)	SR860 V2 (7Z59 / 7Z60)	SR950 (7X11 / 7X12)	SR850 (7X18 / 7X19)	SR850P (7D2F / 2D2G)	SR860 (7X69 / 7X70)	ST50 (7Y48 / 7Y50)	ST250 (7Y45 / 7Y46)	SR150 (7Y54)
4XC7A76757	ThinkSystem Xilinx Alveo U50 Data Center Accelerator Adapter	N	N	N	N	N	N	N	N	N	N	N	N	N

Table 9. Server support (Part 5 of 5)

Part Number	Description	2S Intel V1						Dense V1					
		ST550 (7X09 / 7X10)	SR530 (7X07 / 7X08)	SR550 (7X03 / 7X04)	SR570 (7Y02 / 7Y03)	SR590 (7X98 / 7X99)	SR630 (7X01 / 7X02)	SR650 (7X05 / 7X06)	SR670 (7Y36 / 7Y37)	SD530 (7X21)	SD650 (7X58)	SN550 (7X16)	SN850 (7X15)
4XC7A76757	ThinkSystem Xilinx Alveo U50 Data Center Accelerator Adapter	N	N	N	N	N	Y	Y	N	N	N	N	N

## Operating system support

The Xilinx Alveo U50 adapter supports the operating systems listed in the following table.

**Tip:** This table is automatically generated based on data from [Lenovo ServerProven](#).

Table 10. Operating system support for ThinkSystem Xilinx Alveo U50 Data Center Accelerator Adapter, 4XC7A76757

Operating systems	SR630 (Xeon Gen 2)	SR650 (Xeon Gen 2)	SR645	SR665	SR630 (Xeon Gen 1)	SR630 V2	SR650 (Xeon Gen 1)	SR650 V2
Red Hat Enterprise Linux 8.3	Y	Y	Y	Y	Y	Y	Y	Y

## Regulatory approvals

The Xilinx Alveo U50 adapter has the following hardware certifications:

- Safety Compliance:
  - UL 60950-1, 2nd Edition, 2014-10-14 (Information Technology Equipment - Safety - Part 1: General Requirements)
  - CSA C22.2 No. 60950-1-07, 2nd Edition, 2014-10-14 (Information Technology Equipment - Safety - Part 1: General Requirements)
  - EN 60950-1:2006+A11:2009+A1:2012+A12:2011+A2:2013 (European Union)
  - IEC 60950-1:2005 (2nd Edition); Am 1:2009 (International)
  - EU LVD Directive 2014/35/EU
  - IEC 62368-1:2014 (2nd Edition)
- EMC Compliance:
  - FCC Part 15 – Radiated & Conducted Emissions (USA)
  - CAN ICES-3(A)/NMB-3(A) – Radiated & Conducted Emissions (Canada)
  - CISPR 32 – Radiated & Conducted Emissions (International)
  - EN55032: 2015 – Radiated & Conducted Emissions (European Union)
  - EN55035:2017 – Immunity (European Union)
  - EMC Directive 2014/30/EU
  - VCCI (Class A)– Radiated & Conducted Emissions (Japan)
  - CNS13438 – Radiated & Conducted Emissions (Taiwan)
  - CNS 15663 - RoHS (Taiwan)
  - AS/NZS CISPR 32 – Radiated and Conducted Emissions (Australia/New Zealand)
  - Article 58-2 of Radio Waves Act, Clause 3 (Korea)
- Regulatory Compliance Markings:
  - UL Listed Accessories Mark for the USA and Canada
  - CE mark
  - FCC markings
  - VCCI marking
  - Australian C-Tick mark
  - Korea MSIP mark
  - Taiwan BSMI mark
  - German GS mark

## Physical specifications

The Xilinx Alveo U50 adapter has the following physical specifications:

- Length: 168 mm (6.6 inches)
- Width: 69 mm (2.71 inches)
- Weight: 325g

## Operating environment

The Xilinx Alveo U50 adapter is supported in the following environment:

- Temperature:
  - Operating: 0°C to 50°C (32°F to 122°F)
  - Storage: -40°C to 75°C (-40°F to 167°F)
- Humidity:
  - Operating: 8% to 80%
  - Storage: 5% to 95%

## Warranty

One year limited warranty. When installed in a Lenovo server, the adapter assumes the server's base warranty and any warranty upgrades.

## Related links and publications

For more information, refer to these web resources:

- Xilinx U50 product web page:  
<http://www.xilinx.com/U50>
- Application catalog for Xilinx adapters:  
<https://www.xilinx.com/content/xilinx/en/products/app-store/alveo/all-apps.html>
- Vitis Unified Software Platform:  
<https://www.xilinx.com/products/design-tools/vitis/vitis-platform.html>
- ServerProven compatibility  
<http://www.lenovo.com/us/en/serverproven>

## Related product families

Product families related to this document are the following:

- [100 Gb Ethernet Connectivity](#)
- [Coproductors and Accelerators](#)
- [Ethernet Adapters](#)

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